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IR-1773 (2-2498)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

New York, New York

Mark Pavier

Date: January 22, 2001

Serial No.: 09/718,932

Group Art Unit:

Filed: November 22, 2000

Examiner:

For: POWER SEMICONDUCTOR DIE ATTACH PROCESS USING
CONDUCTIVE ADHESIVE FILM

Asst. Commissioner for Patents

Washington, D.C. 20231

PRELIMINARY AMENDMENT

Sir:

Preliminary to the examination of the above-identified application, please amend the above-identified application as follows:

IN THE SPECIFICATION:

Please amend the specification as follows:

Page 3, line 10, change "8" (second occurrence) to --7--;
line 21, change "11" to --12--.

Page 4, line 27, change "21" to --20--.

IN THE DRAWINGS:

Please amend Fig. 5 as shown in red on the attached copy thereof (in which numerals 20 and 21 are reversed).

REMARKS

This preliminary amendment is being submitted in order to correct typographical errors in the application.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Asst. Commissioner for Patents, Washington, D.C. 20231, on January 22, 2001

Samuel H. Weiner

Name of applicant, assignee or
Registered Representative

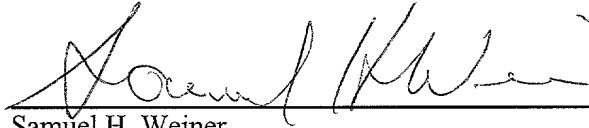
Signature

January 22, 2001

Date of Signature

SHW:gl

Respectfully submitted,



Samuel H. Weiner

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FIG. 1

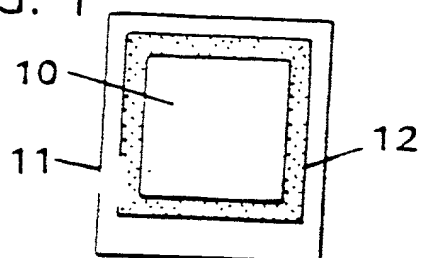


FIG. 3

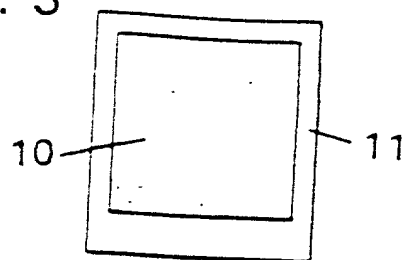


FIG. 2

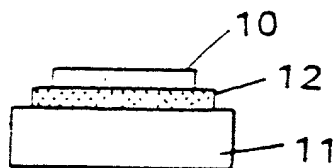


FIG. 4

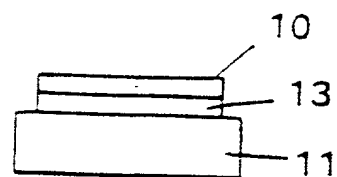


FIG. 5

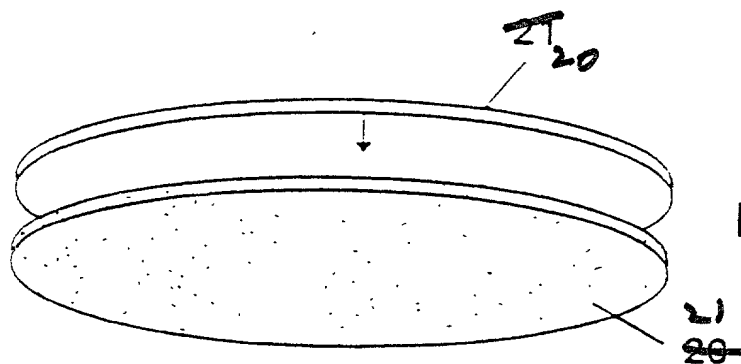


FIG. 6

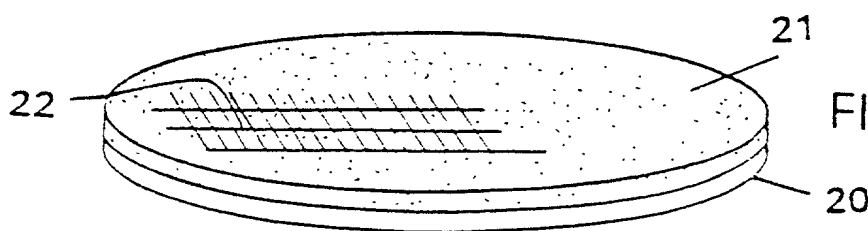


FIG. 7

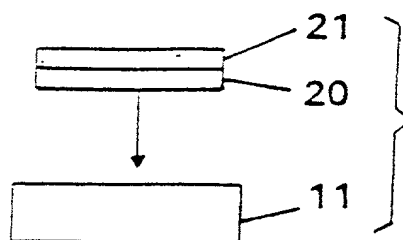
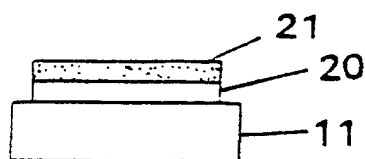


FIG. 8





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Asst. Commissioner of Patents
and Trademarks
Washington, D.C. 20231

REQUEST FOR APPROVAL OF DRAWING CORRECTIONS

Sir:

You are advised that, subject to the approval of the Patent Examiner, applicant proposes to amend drawing Fig. 5 as indicated in red on the enclosed photocopy.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on January 22, 2001

Respectfully submitted,

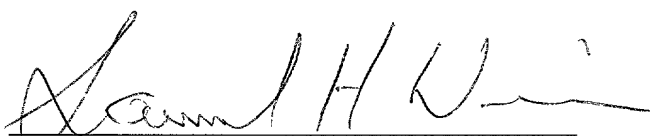
Samuel H. Weiner

Name of applicant, assignee or
Registered Representative


Signature

January 22, 2001

Date of Signature



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SHW:gl

FIG. 1

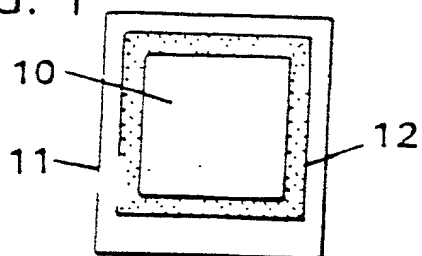


FIG. 3

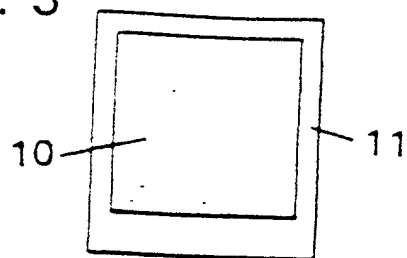


FIG. 2

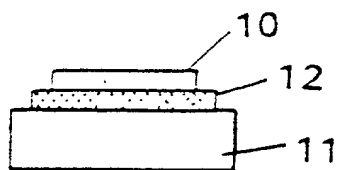


FIG. 4

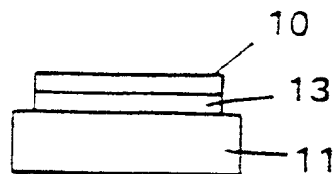


FIG. 5

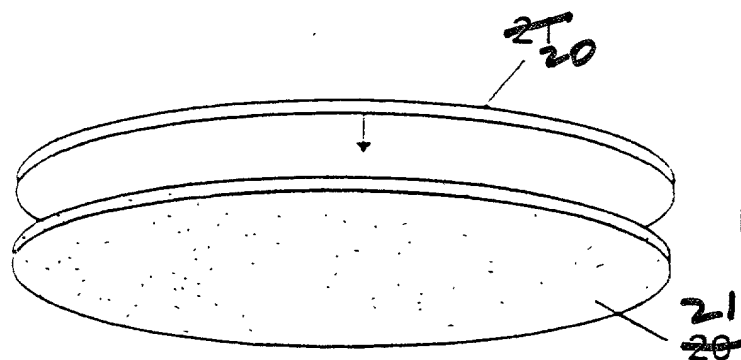


FIG. 6

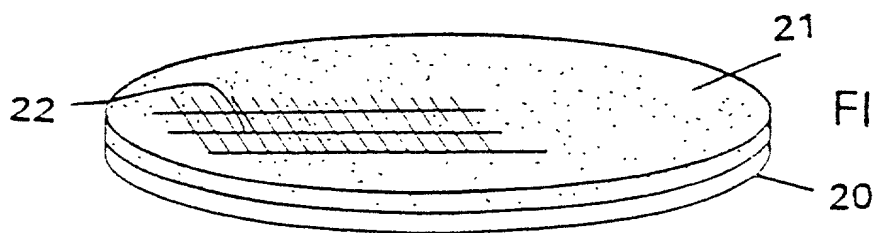


FIG. 7

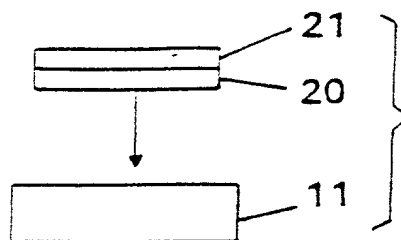


FIG. 8

